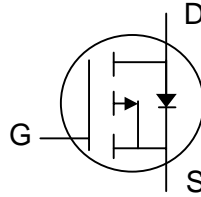




P-channel Enhancement-mode Power MOSFET

- Simple Drive Requirement**
- Low On-resistance**
- Fast Switching Performance**
- RoHS-compliant, halogen-free**

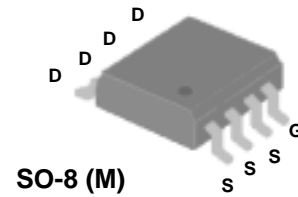


BV_{DSS}	-30V
$R_{DS(ON)}$	14mΩ
I_D	-10.7A

Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, low on-resistance and cost-effectiveness.

The AP4407GM-HF-3 is in the SO-8 package, which is widely used for commercial and industrial surface-mount applications, and is well suited for low voltage applications such as DC/DC converters.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	-30	V
V_{GS}	Gate-Source Voltage	±25	V
I_D at $T_A=25^\circ\text{C}$	Continuous Drain Current ³	-10.7	A
I_D at $T_A= 70^\circ\text{C}$	Continuous Drain Current ³	-8.6	A
I_{DM}	Pulsed Drain Current ¹	-50	A
P_D at $T_A=25^\circ\text{C}$	Total Power Dissipation	2.5	W
	Linear Derating Factor	0.02	W/°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Unit
Rthj-c	Maximum Thermal Resistance, Junction-case	25	°C/W
Rthj-a	Maximum Thermal Resistance, Junction-ambient	50	°C/W

Ordering Information

AP4407GM-HF-3TR : in RoHS-compliant halogen-free SO-8, shipped on tape and reel (3000 pcs/reel)



Electrical Specifications at $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-30	-	-	V
$\Delta BV_{DSS}/\Delta T_j$	Breakdown Voltage Temperature Coefficient	Reference to 25°C , $I_D=-1\text{mA}$	-	-0.015	-	V/ $^\circ\text{C}$
$R_{DS(ON)}$	Static Drain-Source On-Resistance ²	$V_{GS}=-10V, I_D=-10A$	-	-	14	m Ω
		$V_{GS}=-4.5V, I_D=-5A$	-	-	25	m Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1.0	-	-3.0	V
g_{fs}	Forward Transconductance	$V_{DS}=-10V, I_D=-10A$	-	13	-	S
I_{DSS}	Drain-Source Leakage Current ($T_j=25^\circ\text{C}$)	$V_{DS}=-30V, V_{GS}=0V$	-	-	-1	μA
	Drain-Source Leakage Current ($T_j=70^\circ\text{C}$)	$V_{DS}=-24V, V_{GS}=0V$	-	-	-25	μA
I_{GSS}	Gate-Source Leakage	$V_{GS} = \pm 25V$	-	-	± 100	nA
Q_g	Total Gate Charge ²	$I_D=-10A$	-	28	45	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=-24V$	-	5.2	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{GS}=-4.5V$	-	19.8	-	nC
$t_{d(on)}$	Turn-on Delay Time ²	$V_{DS}=-15V$	-	12	-	ns
t_r	Rise Time	$I_D=-1A$	-	11	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=6.8\Omega, V_{GS}=-10V$	-	97	-	ns
t_f	Fall Time	$R_D=15\Omega$	-	72	-	ns
C_{iss}	Input Capacitance	$V_{GS}=0V$	-	1960	3200	pF
C_{oss}	Output Capacitance	$V_{DS}=-25V$	-	590	-	pF
C_{rss}	Reverse Transfer Capacitance	$f=1.0\text{MHz}$	-	465	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$I_S=-2.0A, V_{GS}=0V$	-	-	-1.2	V
t_{rr}	Reverse Recovery Time ²	$I_S=-10A, V_{GS}=0V$	-	36	-	ns
Q_{rr}	Reverse Recovery Charge	$di/dt=100A/\mu s$	-	34	-	nC

Notes:

1. Pulse width limited by maximum junction temperature.
2. Pulse test - pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. Surface mounted on 1 in² copper pad of FR4 board; 125 $^\circ\text{C}/\text{W}$ on minimum copper pad.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

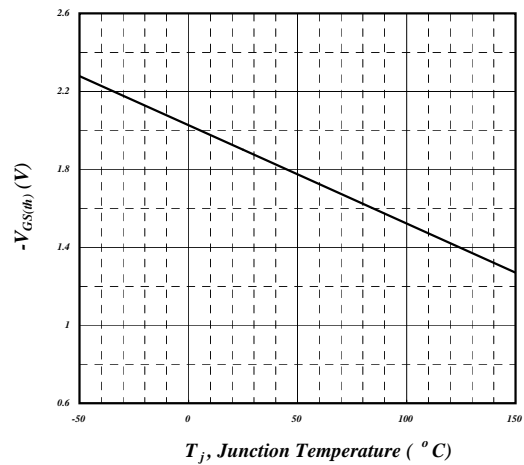
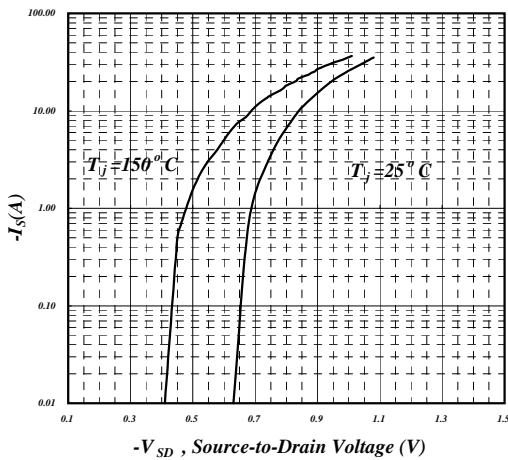
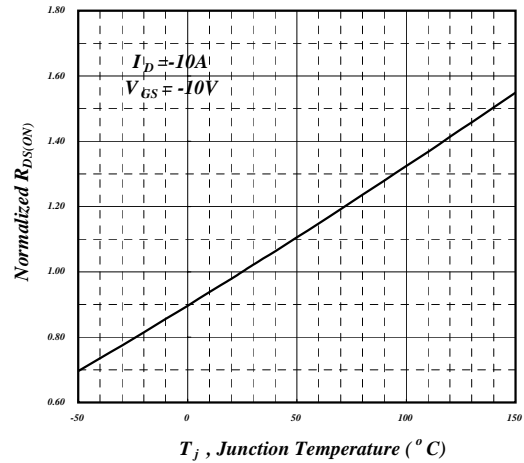
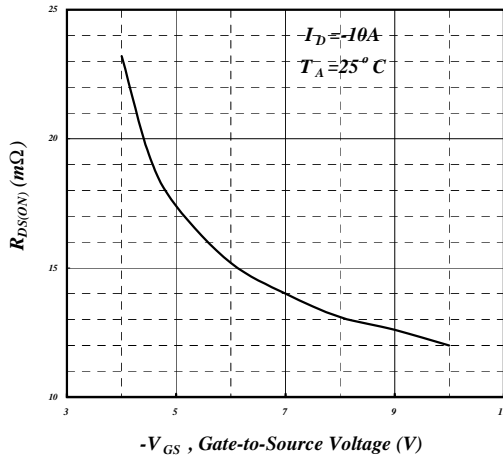
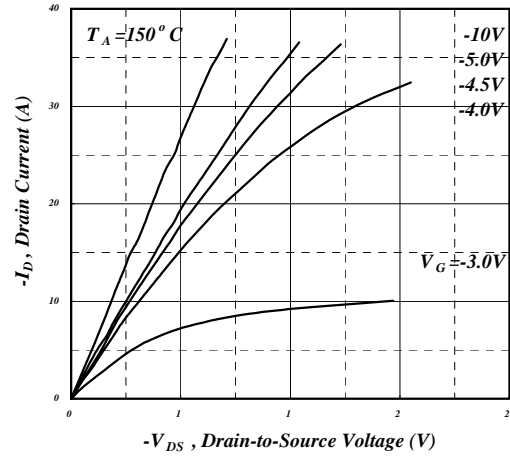
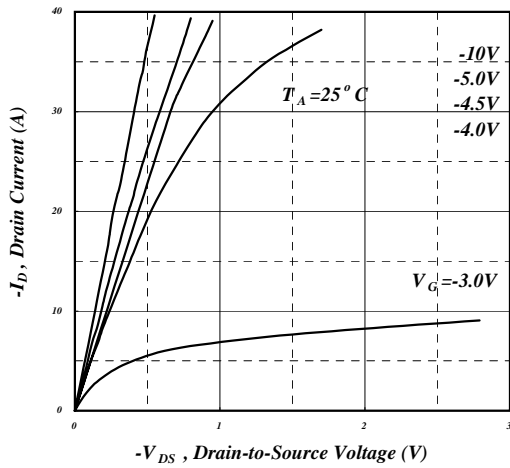
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Typical Electrical Characteristics





Typical Electrical Characteristics (cont.)

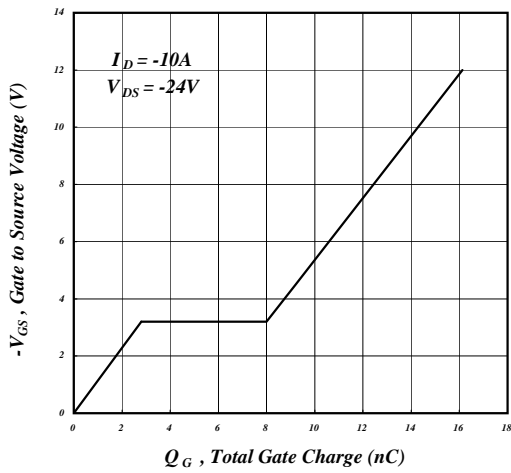


Fig 7. Gate Charge Characteristics

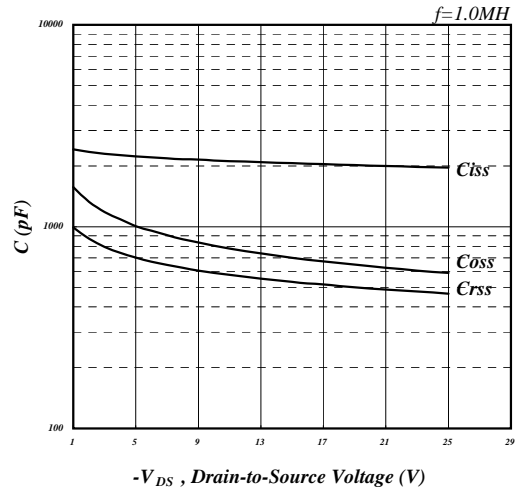


Fig 8. Typical Capacitance Characteristics

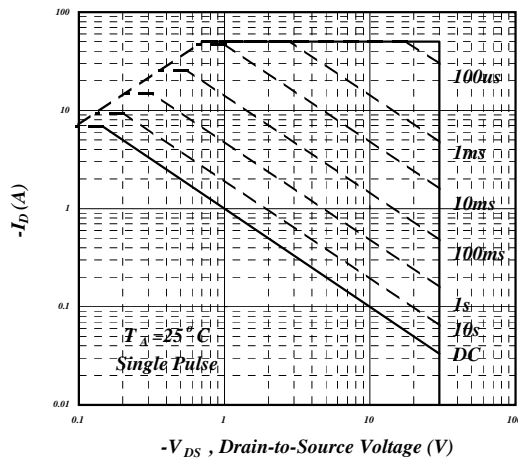


Fig 9. Maximum Safe Operating Area

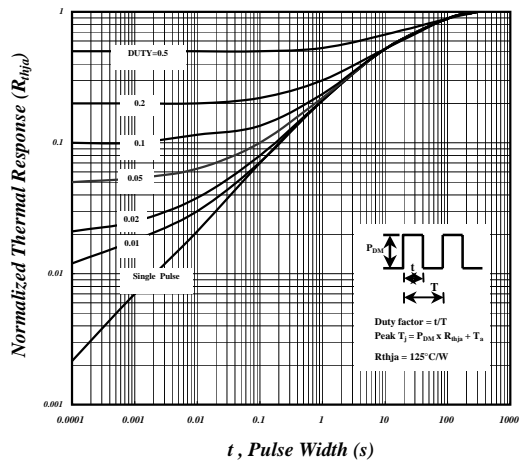


Fig 10. Effective Transient Thermal Impedance

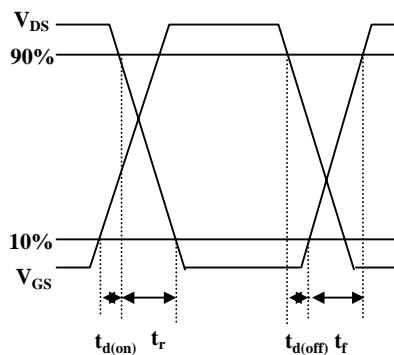


Fig 11. Switching Time Waveforms

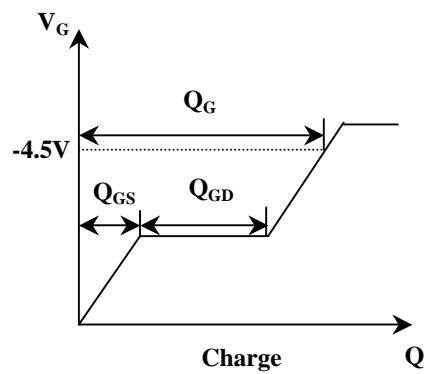
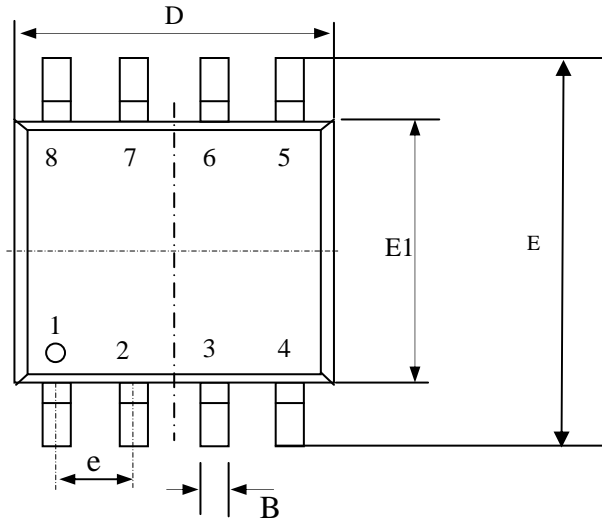


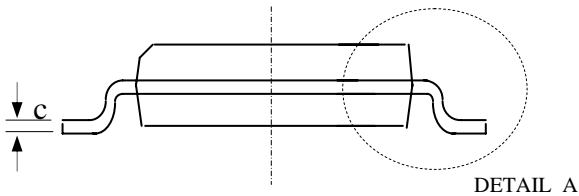
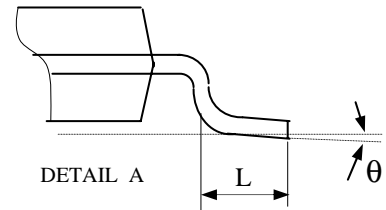
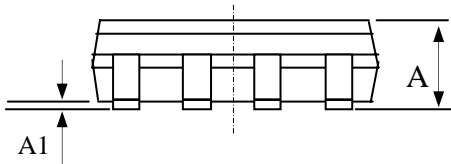
Fig 12. Gate Charge Waveform



Package Dimensions: SO-8

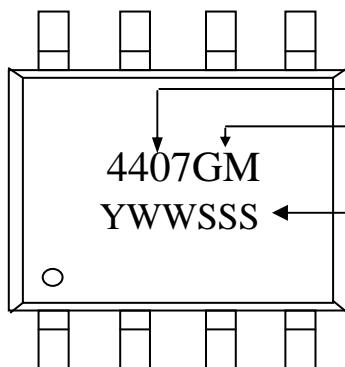


SYMBOLS	Millimeters		
	MIN	NOM	MAX
A	1.35	1.55	1.75
A1	0.10	0.18	0.25
B	0.33	0.41	0.51
C	0.19	0.22	0.25
D	4.80	4.90	5.00
E1	3.80	3.90	4.00
E	5.80	6.15	6.50
L	0.38	0.71	1.27
θ	0	4.00	8.00
e	1.27 TYP		



1. All dimensions are in millimeters.
2. Dimensions do not include mold protrusions.

Marking Information:



- Product: AP4407
- Package: GM = RoHS-compliant halogen-free SO-8
- Date/lot code (YWWSSS)
 - Y: Last digit of the year
 - WW: Work week
 - SSS: Lot code sequence